

PATENT ASSIGNMENT

Electronic Version v1.1
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SUBMISSION TYPE:	NEW ASSIGNMENT				
NATURE OF CONVEYANCE:	ASSIGNMENT				
CONVEYING PARTY DATA					
<table border="1"> <thead> <tr> <th>Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>Chuen Khiang WANG</td> <td>01/15/2013</td> </tr> </tbody> </table>		Name	Execution Date	Chuen Khiang WANG	01/15/2013
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Chuen Khiang WANG	01/15/2013				
RECEIVING PARTY DATA					
Name:	UNITED TEST AND ASSEMBLY CENTER LTD.				
Street Address:	5 Serangoon North Avenue 5				
City:	Singapore				
State/Country:	SINGAPORE				
Postal Code:	554916				
PROPERTY NUMBERS Total: 1					
<table border="1"> <thead> <tr> <th>Property Type</th> <th>Number</th> </tr> </thead> <tbody> <tr> <td>Application Number:</td> <td>13831964</td> </tr> </tbody> </table>		Property Type	Number	Application Number:	13831964
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Application Number:	13831964				
CORRESPONDENCE DATA					
Fax Number:	6568462005				
<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>					
Phone:	+65 9836 9908				
Email:	oa.notification@horizonip.com.sg				
Correspondent Name:	HORIZON IP PTE LTD				
Address Line 1:	7500A Beach Road				
Address Line 2:	#04-306/308 The Plaza				
Address Line 4:	SINGAPORE, SINGAPORE 199591				
ATTORNEY DOCKET NUMBER:	UTACP2013NAT06US0				
NAME OF SUBMITTER:	Dexter CHIN				
<p>Total Attachments: 3 source=UTACP2013NAT06US0-Assignment#page1.tif source=UTACP2013NAT06US0-Assignment#page2.tif source=UTACP2013NAT06US0-Assignment#page3.tif</p>					

CH \$40.00 13831964

ASSIGNMENT

For good and valuable consideration, I, Chuen Khiang WANG, residing at Blk 315C Anchorvale Road #09-180 Singapore 543315, a citizen of Singapore;

Hereby sell, assign, and transfer to **UNITED TEST AND ASSEMBLY CENTER LTD.**, a corporation of **Singapore**, having its principal place of business at **5 Serangoon North Avenue 5, Singapore 554916**,

hereinafter "Assignee", its successors, assigns and legal representatives, the entire right, title and interest in and for the United States and all foreign countries, in and to any and all improvements which are disclosed in the application for United States Letters Patent, which has been executed by the undersigned concurrently here within, and is entitled:

SEMICONDUCTOR PACKAGES AND METHODS OF PACKAGING

SEMICONDUCTOR DEVICES

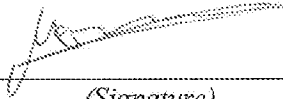
and in and to said application and all divisional, continuing substitute, renewal, reissue, and all other applications for Letters Patent which have been or shall be filed in the United States and all foreign countries on any of said improvements; and in and to all original and reissued patents which have been or shall be filed in the United States and all foreign countries on said improvements;

Agree that Assignee may apply for and receive Letters Patent for said improvements in its own name, and that, when requested, without charge to but at the expense of said Assignee, their successors, assigns, and legal representatives to carry out in good faith the intent and purpose of this agreement, the undersigned will execute all divisional, continuing substitute, renewal, reissue, and all other patent applications on any and all said improvements; execute all rightful oaths, assignments, powers of attorney and other papers; communicate to said Assignee, its successors, assigns, and representatives, all facts known to the undersigned relating to said improvements and the history thereof; and generally do everything possible which said Assignee, its successors, assigns, or representatives shall

consider desirable for aiding in securing and maintaining proper patent protection for said improvements and for vesting title to said improvements and all applications for patents and all patents on said improvements, in said Assignee, its successors, assigns, and legal representatives; and

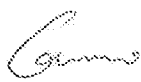
Covenant with said Assignee, its successors, assigns and legal representatives that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.

Date: 15 Jan 13



(Signature)

Chuen Kiang WANG

Witness 1: 

(Signature)

WU CHUN HONG

(Print name)

Witness 2:

(Signature)

(Print name)